

# 10A Peak Current Mode Non-Synchronous PWM Boost(Step-Up) DC-DC Converter

#### PRELIMINARY DATASHEET

# **General Description**

The FH47196 is a current mode boost DC-DC converter. It is PWM circuitry with built-in  $15m\Omega$  power MOSFET make this regulator highly power efficient.

The non-inverting input of error amplifier connects to a 1.20V precision reference voltage. Current mode control and external compensation network make is easy and flexible to stabilize the system.

The FH47196 is available in the ESOP-8L package to fit in space-saving PCB for the application fields.

# Package Type

8-PIN ESOP



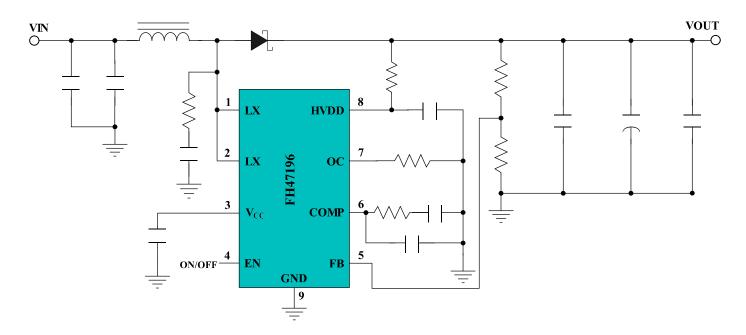
### **Features**

- > Supply Voltage Operating Range: 2.7V to 12.0V
- > Adjustable Output up to 13.0V
- Internal Fixed PWM frequency: 400KHz
- ➤ Precision Feedback Reference Voltage: 1.2V (±2%)
- Internal 15 mΩ, 10A, 14V Power MOSFET
- Shutdown Current: 1.0μA (Max.)
- > Over Temperature Protection
- Internal Soft Start Function
- ➤ Adjustable Over Current Protection: 2.0A ~ 10A
- > Package Type: ESOP-8L

# **Applications**

- > Chargers
- > Handheld Devices
- > LCD Displays
- Portable Products
- > Digital Cameras
- Power Bank

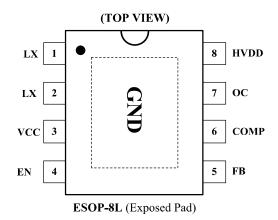
# **Typical Application Circuit**

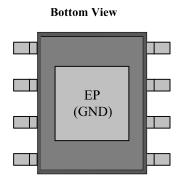




### PRELIMINARY DATASHEET

# **TERMINAL CONFIGURATION**





## **TERMINAL FUNCTION**

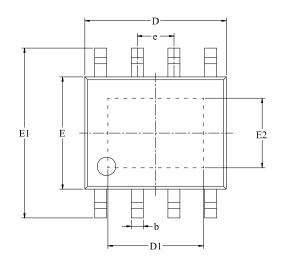
Name	No.	I/O	Description		
LX	1	I	Power Switch Output		
LX	2	I	Power Switch Output		
Vec	3	P	Power Supply for Internal Control Circuits and Gate Drivers		
EN	4	I	Enable Control (Active High)		
FB	5	I	Error Amplifier Inverting Input		
COMP	6	О	Compensation		
OC	7	I	Adjustable Current Limit (Floating Invalid)		
HVDD	8	P	IC Power Supply		
GND	EP	P	IC Ground (Exposed PAD) – Must Connect to Ground		

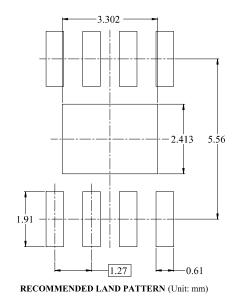


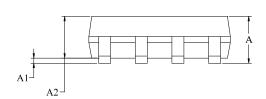
#### PRELIMINARY DATASHEET

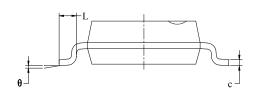
## PACKAGE OUTLINE DIMENSIONS

## **ESOP-8L** (Exposed Pad)









Symbol	Dimen In Milli		Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A		1.700		0.06 7	
A1	0.000	0.100	0.000	0.004	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.007	0.010	
D	4.700	5.100	0.185	0.20 1	
D1	3.202	3.402	0.126	0.134	
Е	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.24 4	
E2	2.313	2.513	0.091	0.099	
e	1.27 BSC		0.050 BSC		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

### Note:

- 1. Package dimensions are in compliance with JEDEC outline: MS-012AA.
- 2. Dimension "D" does not include molding flash, protrusions or gate burrs.
- 3. Dimension "E" does not include inter-lead flash or protrusions.

### **Exposed PAD Dimensions:**

Symbols	Min. (mm)	Max. (mm)		
D1	2.60	3.45		
E1	1.90	2.56		



#### PRELIMINARY DATASHEET

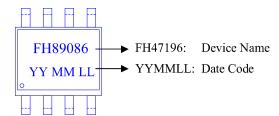
### ORDERING INFORMATION

Part Number	Voltage Range	Features	Operating Temperature	Package Type	Top Mark	SPQ
FH47196S8	2.7V ~ 12.0V	<ul> <li>DC-DC PWM boost converter</li> <li>Current Mode Non-Synchronous</li> <li>Output up to 13.0V</li> <li>Frequency: 400kHz</li> <li>VFB: 1.2V (±2%)</li> <li>Peak Current: 10.0A(max.)</li> </ul>	-25°C to 85°C	ESOP-8L	FH47196 <u>YY</u> <u>MM LL</u>	2500PCS/Reel

#### Note:

- > FH47196 devices are Pb-free and RoHs compliant.
- > The surface prints of our semiconductor devices are subject to change during the production process and do not involve changes in electrical parameters, and we will not separately state the notice.
- > If you have any other custom purchase needs, please contact our sales department.
- > ForDevices reserves the right to amend and legally interpret the electrical parameters of this chip device. (http://www.fordevices.com)

#### **Device Name: ESOP-8L**





### ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

















- > The information described herein is subject to change without notice.
- > ForDevices Inc. is not responsible for any problems caused by circuits or diagrams described herein whose related industrial properties, patents, or other rights belong to third parties. The application circuit examples explain typical applications of the products, and do not guarantee the success of any specific mass-production design.
- > Use of the information described herein for other purposes and/or reproduction or copying without the express permission of ForDevices Inc. is strictly prohibited.
- > The products described herein cannot be used as part of any device or equipment affecting the human body, such as exercise equipment, medical equipment, security systems, gas equipment, or any apparatus installed in airplanes and other vehicles, without prior written permission of ForDevices Inc.
- > Although ForDevices Inc. exerts the greatest possible effort to ensure high quality and reliability, the failure or malfunction of semiconductor products may occur. The user of these products should therefore give thorough consideration to safety design, including redundancy, fire-prevention measures, and malfunction prevention, to prevent any accidents, fires, or community damage that may ensue.

▲ Update by May.2020